1186095

CH \$40.00

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kenichi INOUE	06/06/2007
Fumiaki HONDA	06/06/2007

RECEIVING PARTY DATA

Name:	HITACHI METALS, LTD.	
Street Address:	2-1, Shibaura 1-chome,	
Internal Address:	Minato-ku,	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11860951

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	Q103677
NAME OF SUBMITTER:	Peter D. Olexy

Total Attachments: 1

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PATENT REEL: 020067 FRAME: 0654

W3029-02 (VS)

ASSIGNMENT

As a below named inventor, I hereby declare that:

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RECORDED: 11/05/2007

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI METALS, LTD., a corporation organized under the laws of Japan, located at 2-1, Shibaura 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI METALS, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

MAGNETIC CORE AND APPLIED PRODUCT MAKING USE OF THE SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith,

and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI METALS, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And \hat{I} do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI METALS, LTD.

	Signed on the date(s) ind INVENTOR(S) (発明者フルネームサイン)	ncated aside signatures Date Signed (署名日)	: WITNESSES (立会人サイン)
1)	Yuichi Ozava	September 6, 2007	Norio Zabe
2)	Yuichi OGAWA Masamu Mase	August 30.2007	Norto Jale
3)	Masamu NAOE Myshihito Yoshigawa	August 29, 2007	Norw Yale
4)	Voshihito YOSHIZAWA		
5)			
6)			
7)			
8)			
9)			
-,			

PATENT REEL: 020067 FRAME: 0655